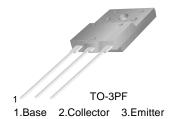


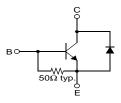
### **KSC5803D**

# High Voltage Color Display Horizontal Deflection Output (Damper Diode Built In)

- High Breakdown Voltage : BV<sub>CBO</sub>=1500V
  High Speed Switching : t<sub>F</sub>=0.1μs (Typ.)
- · Wide S.O.A
- For C-Monitor(85KHz)







### **NPN Triple Diffused Planar Silicon Transistor**

## **Absolute Maximum Ratings** $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector-Base Voltage	1500	V
V <sub>CEO</sub>	Collector-Emitter Voltage	800	V
V <sub>EBO</sub>	Emitter-Base Voltage	6	V
I <sub>C</sub>	Collector Current (DC)	12	Α
I <sub>CP</sub>	Collector Current (Pulse)	24	Α
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)	70	W
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 55 ~ 150	°C

### $\textbf{Electrical Characteristics} \ \, \textbf{T}_{\text{C}} = 25 ^{\circ} \text{C unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
I <sub>CES</sub>	Collector Cut-off Current	V <sub>CE</sub> = 1400V, V <sub>BE</sub> =0			1	mA
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = 800V, I_{E} = 0$			10	μА
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 4V, I_{C} = 0$	50		250	mA
h <sub>FE1</sub>	DC Current Gain	$V_{CE} = 5V, I_{C} = 1A$ $V_{CE} = 5V, I_{C} = 8A$	15 7		40 10	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 8A, I_B = 2A$			3	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = 8A, I_B = 2A$			1.5	V
t <sub>STG</sub>	Storage Time	$V_{CC} = 200V, I_{C} = 7A$			4	μs
t <sub>F</sub>	Fall Time	$I_{B1} = 1.4A, I_{B2} = -2.8A$ $R_L = 28.6\Omega$			0.3	μs
V <sub>F</sub>	Damper Diode Turn On Voltage	I <sub>F</sub> = 8A			2	V

## Thermal Characteristics $\mathsf{T}_C = \!\! 25^{\circ} C$ unless otherwise noted

Symbol	Item	Max	Unit
$R_{\theta jC}$	Thermal Resistance, Junction to Case	1.79	°C/W

# **Typical Characteristics**

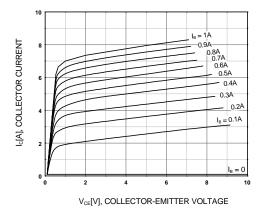


Figure 1. Static Characteristic

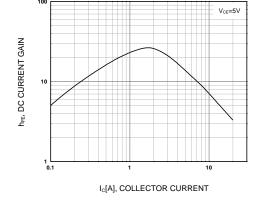


Figure 2. DC current Gain

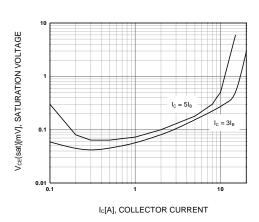


Figure 3. Collector-Emitter Saturation Voltage

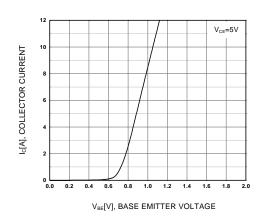


Figure 4. Base-Emitter On Voltage

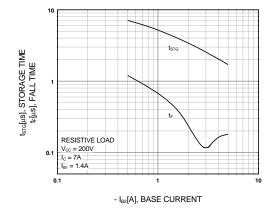


Figure 5. Switching Time

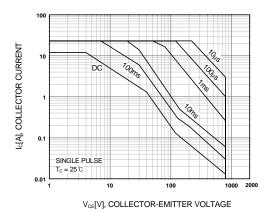


Figure 6. Safe Operating Area

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# Typical Characteristics (Continued)

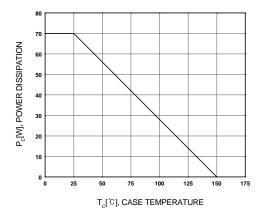
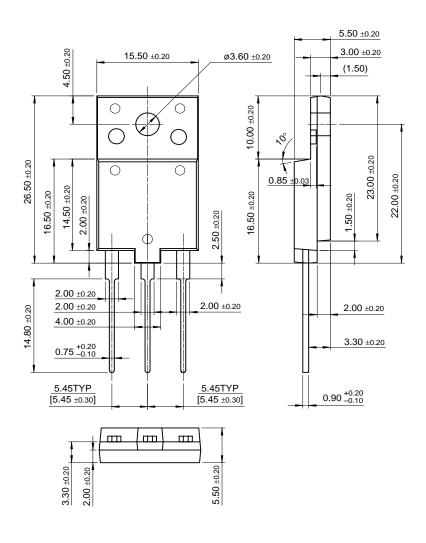


Figure 7. Power Derating

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# **Package Demensions**

# TO-3PF



Dimensions in Millimeters

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